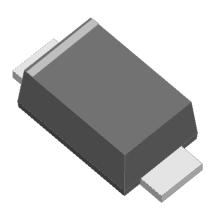




# **Surface Mount Schottky Rectifier**





## **Features**

- •Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

### **Typical Applications**

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

#### **Mechanical Date**

- Package: SOD-323FL
  Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

### ■Maximum Ratings (Tj=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	FM14
Device marking code			FM14
Repetitive peak reverse voltage	VRRM	V	40
Average rectified output current @60Hz sine wave, Resistance load, Tc (FIG.1)	Ю	Α	1.0
Surge(non-repetitive)forward current @ 60Hz half-sine wave,1 cycle, Tj=25℃	IFSM	А	30
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C			60
Current squared time @1ms≲t≲8.3ms Tj =25℃,Rating of per diode	I2t	A2S	3.74
Typical junction capacitance @Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	Cj	pF	43
Storage temperature	T <sub>stg</sub>	$^{\circ}$	-55 ~+150
Junction temperature	Tj	$^{\circ}$	-55 ~+125



# $\blacksquare \textbf{Electrical Characteristics} \ \ (\textbf{T}_{j}\text{=}25\% \ \ \textbf{Unless otherwise specified})$

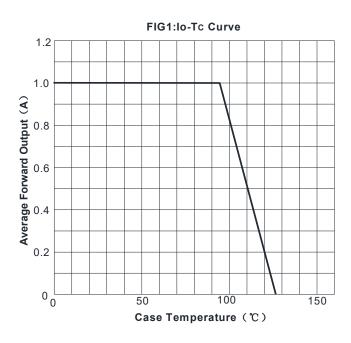
PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	Min	Тур	Max
Dock Forward Voltage	. V	>	I <sub>FM</sub> =1.0A Tj=25℃	-	0.48	0.55
Peak Forward Voltage V <sub>FM</sub>	V	I <sub>FM</sub> =1.0A Tj=100℃	-	-	0.50	
Maximum DC reverse current	I <sub>RRM1</sub>	mA	V <sub>RM</sub> =V <sub>RRM</sub> Tj=25°C	-	-	0.5
at rated DC blocking voltage per diode	I <sub>RRM2</sub>		V <sub>RM</sub> =V <sub>RRM</sub> Tj=100°C	-	-	10

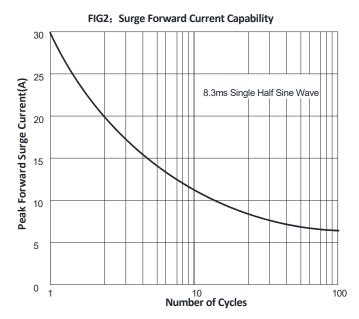
## **■Thermal Characteristics** $(T_j=25^{\circ}\mathbb{C} \text{ Unless otherwise specified})$

PARAMETER	SYMBOL	UNIT	FM14
Thermal Resistance	RøJ-A	- ℃/W -	901)
mermai Resistance	RθЈ-с		46¹)

Note:

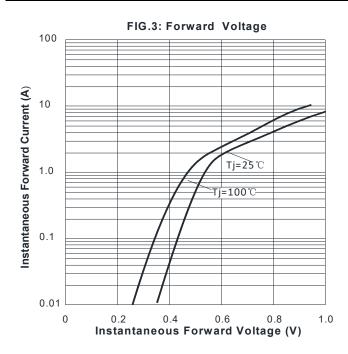
### ■ Characteristics(Typical)

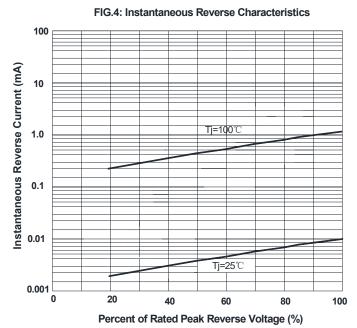




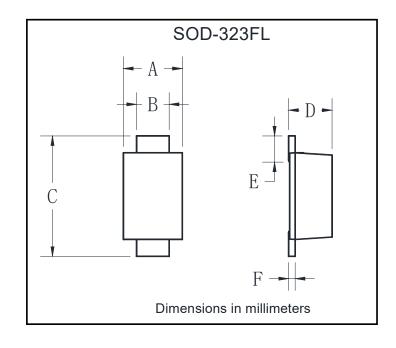
<sup>(1)</sup> Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B with 3mm\*3mm copper pad areas.







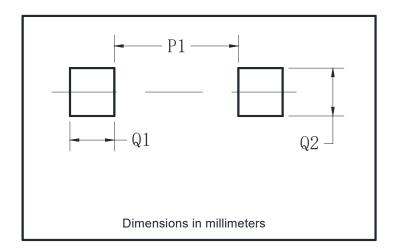
## **■ Outline Dimensions**



SOD-323FL				
Dim	Min	Max		
Α	1.05	1.45		
В	0.90	1.15		
С	2.30	2.70		
D	0.80	1.20		
E	0.25	0.70		
F	0.05	0.25		



### ■ Suggested pad layout



SOD-323FL		
Dim	Millimeters	
P1	1.30	
Q1	1.00	
Q2	1.50	

### **Disclaimer**

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